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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







(NOTE: For new designs, we recommend IR's new products IR2153 and IR21531)

SELF-OSCILLATING HALF-BRIDGE DRIVER

Features

- Floating channel designed for bootstrap operation
 Fully operational to +600V
 Tolerant to negative transient voltage
 dV/dt immune
- Undervoltage lockout
- Programmable oscillator frequency

$$f = \frac{1}{1.4 \times (R_T + 150\Omega) \times C_T}$$

- Matched propagation delay for both channels
- Micropower supply startup current of 125 µA typ.
- Low side output in phase with R_T
- Available in Lead-Free

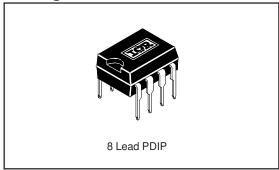
Description

The IR2155 is a high voltage, high speed, self-oscillating power MOSFET and IGBT driver with both high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The front end features a programmable oscillator which is similar to the 555 timer. The output drivers feature a high pulse current buffer stage and an internal deadtime designed for minimum driver cross-conduction. Propagation delays for the two channels are matched to simplify use in 50% duty cycle applications. The floating channel can be used to drive an N-channel power

Product Summary

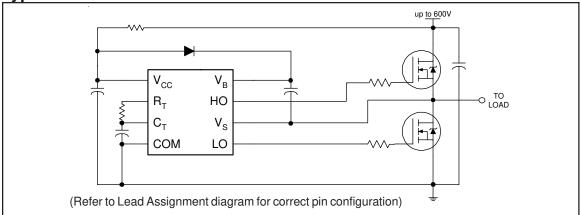
Voffset	600V max.
Duty Cycle	50%
I _O +/-	210 mA / 420 mA
V _{OUT}	10 - 20V
Deadtime (typ.)	1.2 µs

Package



MOSFET or IGBT in the high side configuration that operates off a high voltage rail up to 600 volts.

Typical Connection



Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

Parameter		Va	Value			
Symbol	Symbol Definition		Max.	Units		
V _B	High Side Floating Supply Voltage	-0.3	625			
Vs	High Side Floating Supply Offset Voltage	V _B - 25	V _B + 0.3			
V _{HO}	High Side Floating Output Voltage	V _S - 0.3	V _B + 0.3	_v		
V _{LO}	Low Side Output Voltage	-0.3	V _{CC} + 0.3]		
V _{RT}	R _T Voltage	-0.3	V _{CC} + 0.3			
V _{CT}	C _T Voltage	-0.3	V _{CC} + 0.3			
Icc	Supply Current (Note 1)	_	25	mA		
I _{RT}	R _T Output Current	-5	5	l IIIA		
dV _S /dt	Allowable Offset Supply Voltage Transient	_	50	V/ns		
PD	Package Power Dissipation @ T _A ≤ +25°C (8 Lead DIP)	_	1.0	w		
	(8 Lead SOIC)	_	0.625] VV		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (8 Lead DIP)	_	125	°C/W		
	(8 Lead SOIC)	_	200	0/00		
TJ	Junction Temperature	_	150			
T _S	Storage Temperature	-55	150	°C		
TL	Lead Temperature (Soldering, 10 seconds)	_	300			

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The V_S offset rating is tested with all supplies biased at 15V differential.

Parameter		Va		
Symbol	Definition	Min.	Max.	Units
V _B	High Side Floating Supply Absolute Voltage	V _S + 10	V _S + 20	
Vs	High Side Floating Supply Offset Voltage	_	600	V
V _{HO}	High Side Floating Output Voltage	Vs	V _B	v
V _{LO}	Low Side Output Voltage	0	Vcc	
Icc	Supply Current (Note 1)	_	5	mA
T _A	Ambient Temperature	-40	125	°C

Note 1: Because of the IR2155's application specificity toward off-line supply systems, this IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6V. Therefore, the IC supply voltage is normally derived by forcing current into the supply lead (typically by means of a high value resistor connected between the chip V_{CC} and the rectified line voltage and a local decoupling capacitor from V_{CC} to COM) and allowing the internal zener clamp circuit to determine the nominal supply voltage. Therefore, this circuit should not be driven by a DC, low impedance power source of greater than V_{CLAMP}.

Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS}) = 12V, C_L = 1000 pF and T_A = 25°C unless otherwise specified.

	Parameter	Value		Value			
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions	
t _r	Turn-On Rise Time	_	80	120	ns		
t _r	Turn-Off Fall Time	_	40	70	115		
DT	Deadtime	0.50	1.20	2.25	μs		
D	R _T Duty Cycle	48	50	52	%		

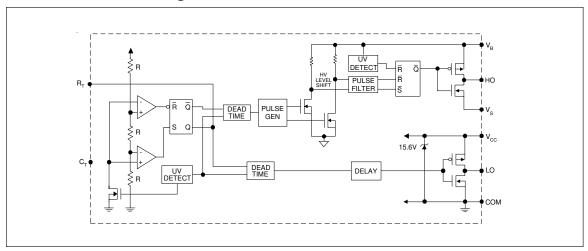
Static Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS}) = 12V, C_L = 1000 pF, C_T = 1 nF and T_A = 25°C unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

	Parameter		Value			
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
fosc	Oscillator Frequency	19.4	20.0	20.6	kHz	$R_T = 35.7 \text{ k}\Omega$
		94	100	106	KUZ	$R_T = 7.04 \text{ k}\Omega$
V _{CLAMP}	V _{CC} Zener Shunt Clamp Voltage	14.4	15.6	16.8		$I_{CC} = 5 \text{ mA}$
V _{CT+}	2/3 V _{CC} Threshold	7.8	8.0	8.2	V	
V _{CT-}	1/3 V _{CC} Threshold	3.8	4.0	4.2		
V _{CTUV}	C _T Undervoltage Lockout	_	20	50		$2.5V < V_{CC} < V_{CCUV}$
V _{RT+}	R_T High Level Output Voltage, V_{CC} - R_T	_	0	100		$I_{RT} = -100 \mu A$
		_	200	300		I _{RT} = -1 mA
V _{RT-}	R _T Low Level Output Voltage	_	20	50	mV	I _{RT} = 100 μA
		_	200	300	1111	I _{RT} = 1 mA
V _{RTUV}	RT Undervoltage Lockout, V _{CC} - R _T	_	0	100		$2.5V < V_{CC} < V_{CCUV}$
V _{OH}	High Level Output Voltage, V _{BIAS} - V _O	_	_	100		$I_O = 0A$
V _{OL}	Low Level Output Voltage, VO	_	_	100		$I_O = 0A$
I _{LK}	Offset Supply Leakage Current	_	_	50		$V_{B} = V_{S} = 600V$
I _{QBS}	Quiescent V _{BS} Supply Current	_	70	150		
I _{QBSUV}	Micropower V _{BS} Supply Startup Current		55	125	μA	
I _{QCC}	Quiescent V _{CC} Supply Current		500	1000	μ	
Iqccuv	Micropower V _{CC} Supply Startup Current		70	150		
I _{CT}	C _T Input Current	_	0.001	1.0		
V _{BSUV+}	V _{BS} Supply Undervoltage Positive Going Threshold	7.7	8.4	9.2	.,	
V _{BSUV} -	V _{BS} Supply Undervoltage Negative Going Threshold	7.3	8.1	8.9	V	
V _{BSUVH}	V _{BS} Supply Undervoltage Lockout Hysteresis	100	400	_	mV	
V _{CCUV+}	V _{CC} Supply Undervoltage Positive Going Threshold	7.7	8.4	9.2		
V _{CCUV} -	V _{CC} Supply Undervoltage Negative Going Threshold	7.4	8.1	8.9	V	
V _{CCUVH}	V _{CC} Supply Undervoltage Lockout Hysteresis	200	400	_	mV	
I _{O+}	Output High Short Circuit Pulsed Current	210	250	_	mA	$V_O = 0V$
I _{O-}	Output Low Short Circuit Pulsed Current	420	500	_	IIIA	V _O = 15V

IR2155&(PbF)

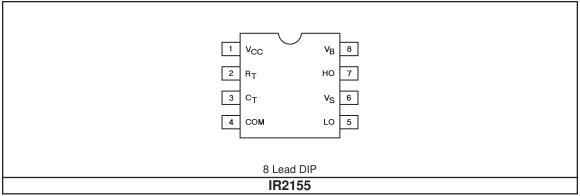
Functional Block Diagram



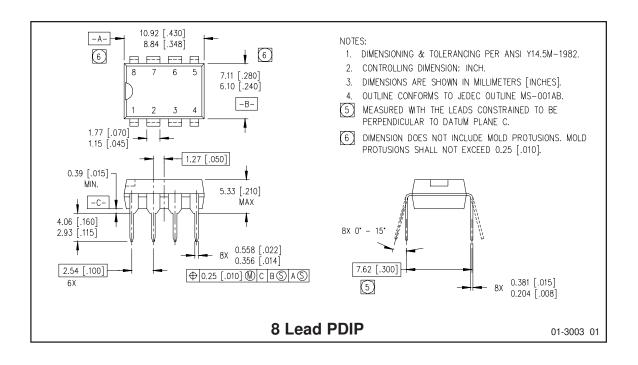
Lead Definitions

Le	ad
Symbol	Description
R _T	Oscillator timing resistor input,in phase with LO for normal IC operation
CT	Oscillator timing capacitor input, the oscillator frequency according to the following equation:
	$f = \frac{1}{1.4 \times (R_T + 150\Omega) \times C_T}$
	where 150 Ω is the effective impedance of the R _T output stage
V _B	High side floating supply
НО	High side gate drive output
Vs	High side floating supply return
V _{CC}	Low side and logic fixed supply
LO	Low side gate drive output
COM	Low side return

Lead Assignments



IR2155&(PbF)



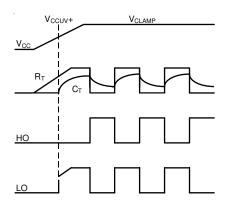


Figure 1. Input/Output Timing Diagram

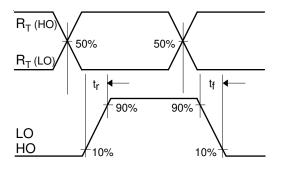


Figure 2. Switching Time Waveform Definitions

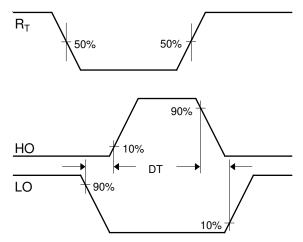
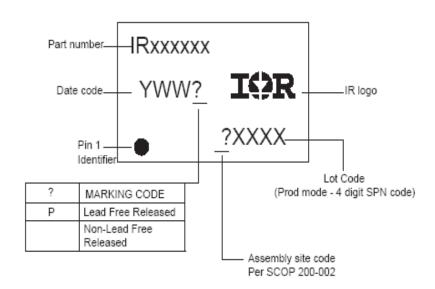


Figure 3. Deadtime Waveform Definitions

LEADFREE PART MARKING INFORMATION



ORDER INFORMATION

Basic Part (Non-Lead Free)

Lead-Free Part

8-Lead PDIP IR2155 order IR2155

8-Lead PDIP IR2155

order IR2155PbF



This product has been designed and qualified for the Industrial market.

Qualification Standards can be found on IR's Web Site.

Data and specifications subject to change without notice.

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC Fax: (310) 252-7903

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